

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAOYUKI OBA	07/03/2019
AKIHIRO YAMAMOTO	07/08/2019
KATSUMI OGAWA	07/05/2019
HIROKI IWATA	07/09/2019
RECEIVING PARTY DATA	
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City:	SUITA-SHI, OSAKA
State/Country:	JAPAN
Postal Code:	564-0063
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State/Country:	JAPAN
Postal Code:	485-8551
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16509925
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NAME OF SUBMITTER:	GRANT E. COFFIELD
SIGNATURE:	/Grant E. Coffield/
DATE SIGNED:	07/12/2019
Total Attachments: 5 source=94_ASSGN#page1.tif source=94_ASSGN#page2.tif source=94_ASSGN#page3.tif source=94_ASSGN#page4.tif source=94_ASSGN#page5.tif	

ASSIGNMENT

WHEREAS, We, Naoyuki OBA; Akihiro YAMAMOTO; and Katsumi OGAWA, each having an address at YODOGAWA HU-TECH CO., LTD., 3-4-8 Esaka-cho, Suita-shi, Osaka, 564-0063, Japan, and Hiroki IWATA, having an address at CKD CORPORATION, 250, Ouji 2-chome, Komaki, Aichi, 485-8551, Japan, have invented certain new and useful improvements in CHECKING TOOL FOR TUBE COUPLER, for which Japanese Patent Application No. 2019-105396 was filed on June 5, 2019, and Japanese Patent Application No. 2018-134971 was filed on July 18, 2018, and for which an application entitled CHECKING TOOL FOR TUBE COUPLER for Letters Patent of the United States is about to be made, and;

AND WHEREAS, YODOGAWA HU-TECH CO., LTD., a Japanese corporation, having a place of business at 2-4-8 Esaka-cho, Suita-shi, Osaka, 564-0063, Japan, is desirous of acquiring an undivided fifty-percent (50%) interest in our entire right, title and interest in and to said application for Letters Patent of the United States and the inventions and improvements therein disclosed for the United States of America;

AND WHEREAS, CKD Corporation, a Japanese corporation, having a place of business at 250, Ouji 2-chome, Komaki, Aichi, 485-8551, Japan, is desirous of acquiring an undivided fifty-percent (50%) interest in our entire right, title and interest in and to said application for Letters Patent of the United States and the inventions and improvements therein disclosed for the United States of America; hereinafter collectively called the "assignees",

NOW, THEREFORE, in consideration of One (\$1.00) Dollar and other good and valuable consideration paid to us by said assignees, receipt whereof we hereby acknowledge, we do hereby assign, sell, transfer, and set over unto each of said assignees an undivided fifty percent (50%) interest in our entire respective right(s), title(s) and interest(s) in and to said application for Letters Patent of the United States and the inventions and improvements therein disclosed for the United States of America, and any Letters Patent which may issue therefor in the United States and all divisions, reissues, continuations, renewals, and/or extensions thereof in the United States including all priority rights under the International Convention associated

therewith for the United States, said assignees to have and to hold the interests herein assigned to the full ends of the terms of said Letters Patent and any and all divisions, reissues, continuations, renewals, and/or extensions thereof in the United States, respectively, as fully and entirely as the same would have been held and enjoyed by us had this assignment not been made.

The United States Commissioner of Patents and Trademarks is requested to issue such Letters Patent in accordance herewith. We covenant that we are the lawful owners of the said applications, inventions, and improvements, that the same are unencumbered, that no license has been granted to make, use, or vend the said inventions or improvements or any of them, and that we have the full right to make this assignment.

And for the consideration aforesaid, we agree that we will communicate to said assignees or the representatives thereof any facts known to us respecting said inventions and improvements, and will, upon request, but without expense to us, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, renewal, and/or extension applications for the United States, make all rightful oaths, and generally do all other and further lawful acts, deemed necessary or expedient by said assignees or by counsel for said assignees, to assist or enable said assignees to obtain and enforce full benefits from the rights and interests herein assigned. This assignment shall be binding upon our heirs, executors, administrators, and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors, and/or assigns, as the case may be, of said assignees.

EXECUTED July 3, 2019.

Naoyuki Oba
Naoyuki OBA

WITNESS:

Takanobu Matsumoto

Date: July 3, 2019

EXECUTED July 8, 2019.

Akihiro YAMAMOTO

Akihiro YAMAMOTO

WITNESS:

Takanobu Matsumoto

Date: July 8, 2019.

EXECUTED July 5th, 2019.

K. Ogawa
Katsumi OGAWA

WITNESS:

Takanobu Mitsumoto

Date: July 5, 2019

132578-00094

EXECUTED July 9, 2019.

Hiroki IWATA
Hiroki IWATA

WITNESS:

Michinori IKUJI

Date: July 9, 2019